



PATENT
Atty. Dkt. No. AMAT/6060/CMP/ECP/RKK

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:
Olgado, et al.

Serial No.: 10/043,561

Confirmation No.: 7947

Filed: January 8, 2002

**For: SYSTEM FOR PLANARIZING
METAL CONDUCTIVE LAYERS**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Group Art Unit: 1765

Examiner: Kin Chan Chen

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CERTIFICATE OF MAILING

37 CFR 1.8

I hereby certify that this correspondence is being deposited on 9/24, 2003 with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

9/24/03
Date

Ken R. Dyer
Signature

RESPONSE TO OFFICE ACTION DATED JUNE 24, 2003

In response to the Office Action dated June 24, 2003, having a shortened statutory period for response set to expire on September 24, 2003, please enter this response and reconsider the claims pending in the application for reasons discussed below. The Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/6060/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are shown in the listing of the claims which begins on page 2 of this paper. **Amendments to the Drawings** begin on page 10 of this paper and include both attached replacement sheets and annotated sheets showing changes. **Remarks/Arguments** begin on page 11 of this paper.